

Electrolyte-Gated Transistors using n-type organic molecular semiconductors: the case of PCBM as Channel Material

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Abstracts:

Electrolyte-gated transistors (EGTs) using electrolytes as the gating medium are of interest since the exceptionally high capacitance of the electrical double layer forming at the electrolyte/transistor channel interface permits current modulations of several orders of magnitude, at relatively low gate voltages, sub 2V [1]. Electrolyte gating is a powerful approach to produce large charge carrier densities (ca 10^{14} cm⁻²) in semiconductors. Room temperature ionic liquids (RTILs) show great potential as gating media for their physico-chemical properties, such as negligible volatility, electrochemical stability windows up to ca 5 V, ionic conductivity up to 10 mS·cm⁻¹ [2]. N-type organic transistors are of relevance for organic p-n junctions, bipolar transistors and complementary integrated circuits for flexible, large-area, and low-cost electronic applications [3]. In this work, we will report on EGTs with RTILs based on bis(trifluoromethylsulfonyl)imide ([TFSI]) anions and 1-ethyl-3-methylimidazolium ([EMIM]) cations as the gating medium and phenyl-C61-butyric acid methyl ester (PCBM) as the n-type organic molecular semiconducting channel material. Cyclic voltammeteries in transistor configuration (where the working electrode is the channel material included between the source and drain electrodes and the reference is a high surface area gate electrode) were recorded to bridge the gap between the redox properties of PCBM films, characterized by a certain supramolecular organization, and the modulation of the film electrical conductance. Drain-source voltages, V_{ds} , as low as 100mV and gate-source voltages, V_{gs} , within the range 0~1.25 V, 0~1.7 V, 0~1.9 V were explored. We observed typical transistor behavior for our PCBM EGTs with I_{ds}/I_{gs} and ON/OFF ratios of around 10, ON/OFF ratios increasing with the increase of the gate voltage range. A correlation has been established between the redox peaks observed in the cyclic voltammetry with the morphology/structure of the films as deduced by Atomic Force Microscopy and XRD obtained at glancing angles and the corresponding transistor behavior.

References:

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